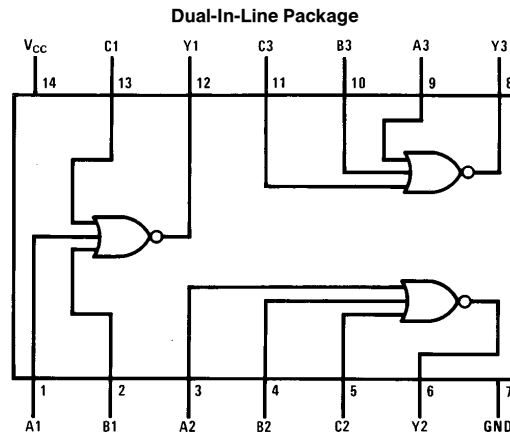


DM54LS27/DM74LS27 Triple 3-Input NOR Gates

General Description

This device contains three independent gates each of which performs the logic NOR function.

Connection Diagram



TL/F/6359-1

Order Number DM54LS27J, DM54LS27W,
DM54LS27E, DM74LS27M or DM74LS27N
See NS Package Number E20A, J14A, M14A, N14A or W14B

Function Table

$$Y = \overline{A + B + C}$$

Inputs			Output
A	B	C	Y
L	L	L	H
X	X	H	L
X	H	X	L
H	X	X	L

H = High Logic Level
L = Low Logic Level
X = Either Low or High Logic Level

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	
DM54LS and 54LS	-55°C to +125°C
DM74LS	0°C to +70°C

Storage Temperature Range -65°C to +150°C

Note: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	DM54LS27			DM74LS27			Units
		Min	Nom	Max	Min	Nom	Max	
V _{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High Level Input Voltage	2			2			V
V _{IL}	Low Level Input Voltage			0.7			0.8	V
I _{OH}	High Level Output Current			-0.4			-0.4	mA
I _{OL}	Low Level Output Current			4			8	mA
T _A	Free Air Operating Temperature	-55		125	0		70	°C

Electrical Characteristics over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 1)	Max	Units
V _I	Input Clamp Voltage	V _{CC} = Min, I _I = -18 mA			-1.5	V
V _{OH}	High Level Output Voltage	V _{CC} = Min, I _{OH} = Max, V _{IL} = Max	DM54 2.5	3.4		V
V _{OL}	Low Level Output Voltage	V _{CC} = Min, I _{OL} = Max, V _{IH} = Min	DM54		0.4	V
			DM74		0.35	
		I _{OL} = 4 mA, V _{CC} = Min	DM74		0.25	0.4
I _I	Input Current @ Max Input Voltage	V _{CC} = Max, V _I = 7V			0.1	mA
I _{IH}	High Level Input Current	V _{CC} = Max, V _I = 2.7V			20	μA
I _{IL}	Low Level Input Current	V _{CC} = Max, V _I = 0.4V			-0.36	mA
I _{OS}	Short Circuit Output Current	V _{CC} = Max (Note 2)	DM54	-20	-100	mA
			DM74	-20	-100	
I _{CCH}	Supply Current with Outputs High	V _{CC} = Max		2	4	mA
I _{CCL}	Supply Current with Outputs Low	V _{CC} = Max		3.4	6.8	mA

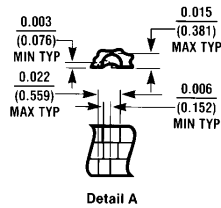
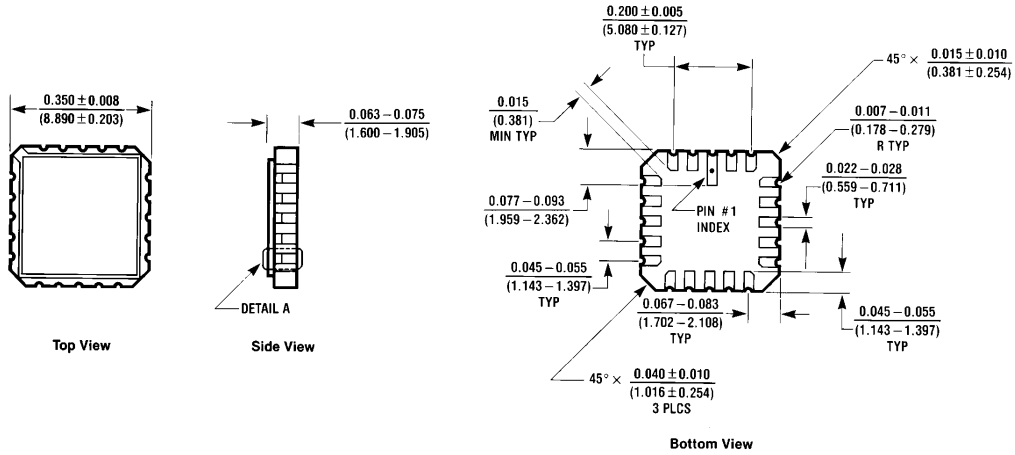
Switching Characteristics at V_{CC} = 5V and T_A = 25°C

Symbol	Parameter	DM54		DM74				Units
		R _L = 2 kΩ						
		C _L = 15 pF		C _L = 15 pF		C _L = 50 pF		
		Min	Max	Min	Max	Min	Max	
t _{PLH}	Propagation Delay Time Low to High Level Output	3	13	3	13	5	18	ns
t _{PHL}	Propagation Delay Time High to Low Level Output	3	13	3	10	4	15	ns

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

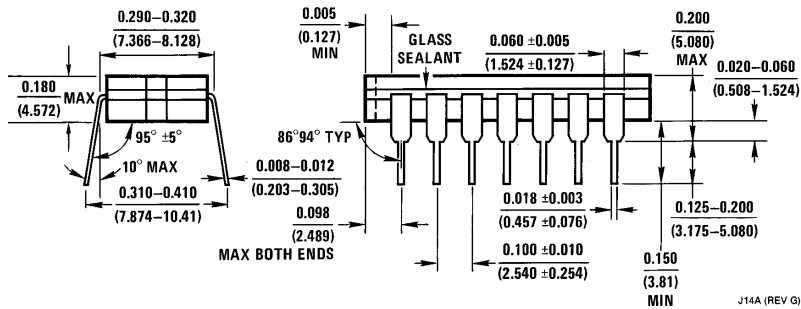
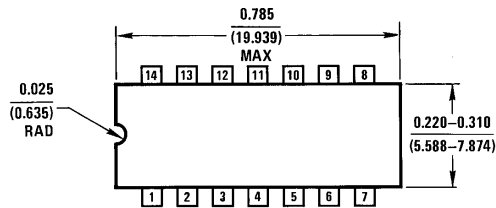
Note 2: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Physical Dimensions inches (millimeters)



Ceramic Leadless Chip Carrier Package (E)
 Order Number DM54LS27E
 NS Package Number E20A

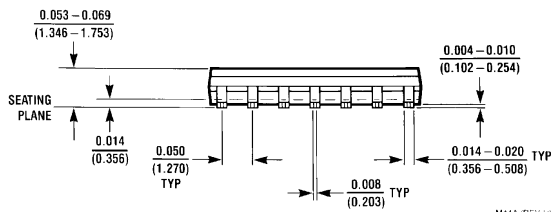
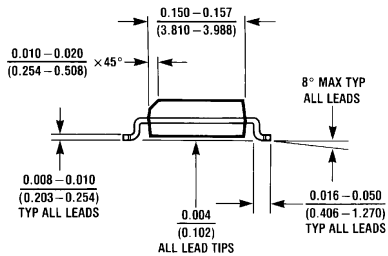
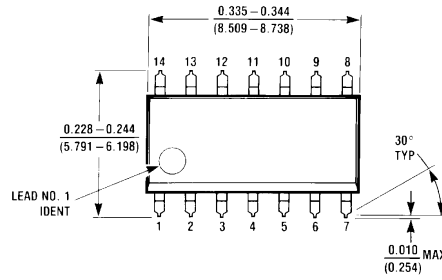
E20A (REV D)



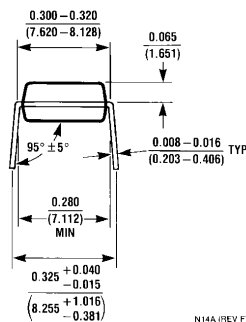
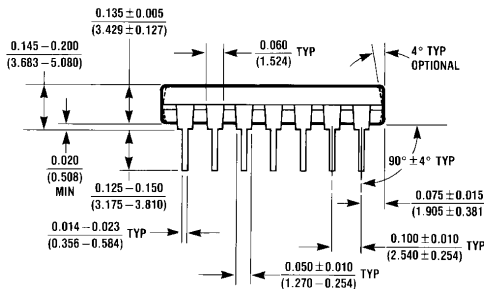
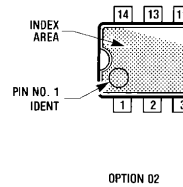
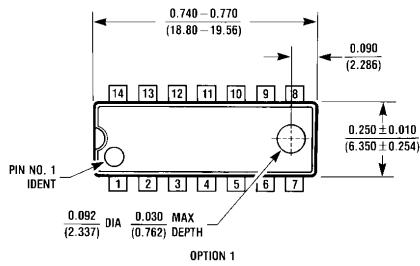
14-Lead Ceramic Dual-In-Line Package (J)
 Order Number DM54LS27J
 NS Package Number J14A

J14A (REV G)

Physical Dimensions inches (millimeters) (Continued)

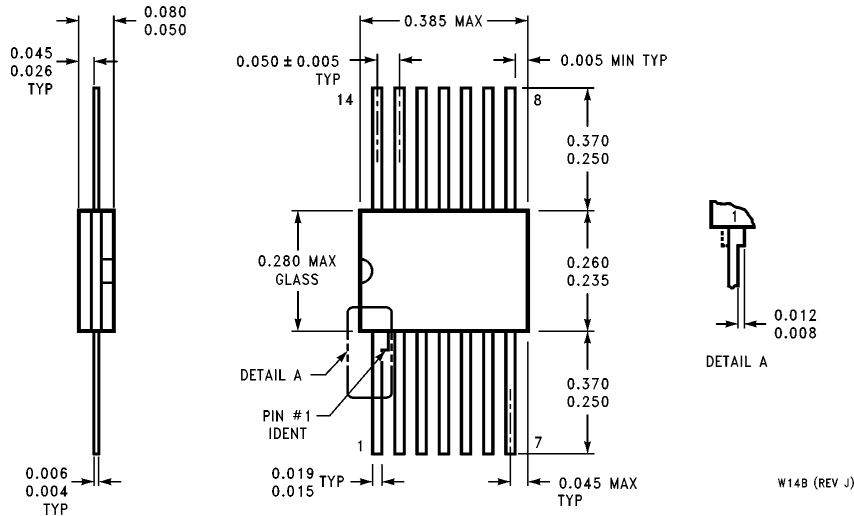


14-Lead Small Outline Molded Package (M)
Order Number DM74LS27M
NS Package Number M14A



14-Lead Molded Dual-In-Line Package (N)
Order Number DM74LS27N
NS Package Number N14A

Physical Dimensions inches (millimeters) (Continued)



14-Lead Ceramic Flat Package (W)
Order Number DM54LS27W
NS Package Number W14B

W14B (REV J)

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National Semiconductor Corporation
 1111 West Bardin Road
 Arlington, TX 76017
 Tel: 1(800) 272-9959
 Fax: 1(800) 737-7018

National Semiconductor Europe
 Fax: (+49) 0-180-530 85 86
 Email: cnjwge@tevm2.nsc.com
 Deutsch Tel: (+49) 0-180-530 85 85
 English Tel: (+49) 0-180-532 78 32
 Français Tel: (+49) 0-180-532 93 58
 Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor Hong Kong Ltd.
 19th Floor, Straight Block,
 Ocean Centre, 5 Canton Rd.
 Tsimshatsui, Kowloon
 Hong Kong
 Tel: (852) 2737-1600
 Fax: (852) 2736-9960

National Semiconductor Japan Ltd.
 Tel: 81-043-299-2309
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